

Features

- 5050 with integrated high quality constant current IC and RGBW LED chips.
- Built-in IC, with high precision of constant current and internal RGBW chips spectral processing in advance.
- Single line data transmission (return to zero code).
- Specific Shaping Transmit Technology number of LED stacked is not restricted.
- Cascading Enhancement Technology any 2 LED spacing can be up to 10 meters
- Data transfer rate of 800 kbp/s at 30 frames per second.
- RGBW output port PWM control can achieve 256 grey level adjustments.
- Upon powering up, IC performs self-inspection then lights connection on the pin B lamp.
- SA-I Anti-interference patent technology for single line data transmission.
- Built-in power supply reverse connect protection module, reversed power input will not damage the IC.

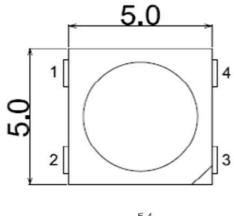
Description

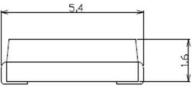
The IN-PI55QATPRPGPBPW-XX is 5.0*5.0*1.6mm RGBW LED with integrated IC. It is a SMD type LED which can be used in various applications.

Applications

- Full color LED string light
- LED full color module
- LED guardrail tube
- LED scene lighting
- LED point light
- LED pixel screen
- LED shaped screen

Package Outline Dimensions & Pin Configuration





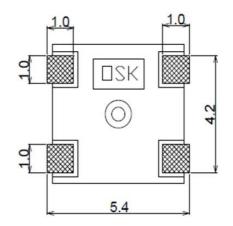


Figure 1. IN-PI55QATPRPGPBPW-XX Package Outline Dimensions



Pin Configuration

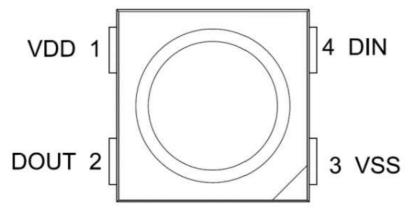


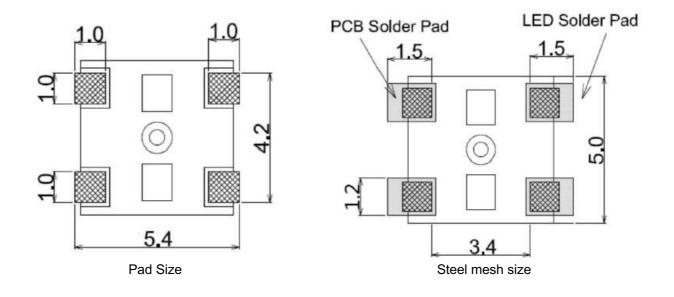
Figure 2. IN- PI55QATPRPGPBPW-XX Pin Configuration

Notes:

1. Dimension in millimeter, tolerance is $\pm 0.1 \text{mm}$ unless otherwise noted.

Number	Symbol	Function Description
1	VDD	Power supply LED
2	DOUT	Control data signal output
3	VSS	Ground
4	DIN	Control data signal input

Soldering Pad Size





Absolute Maximum Rating (Ta = 25 °C, VSS=0V)

Parameter	Symbol	Range	Unit
Power supply voltage	Vdd	+3.5~+5.5	V
Logic input voltage	Vin	-0.5 ~VDD+0.5	V
Working temperature	Торт	-45 ~ +85	°C
Storage temperature	Тѕтд	-50 ~ +150	°C
ESD pressure(HBM)	Vesd	4K	V
ESD pressure(DM)	Vesd	200	V

LED Characteristics (Ta = 25°C)

Color	12mA				
Color	Wavelength(nm)	Light Intensity(mcd)			
Red	620-630	200-400			
Green	515-530	700-1000			
Blue	460-470	100-200			
Cool White	6000K	1500-2200			
Neutral White	4000k	1500-2200			
Warm White	3000k	1500-2200			



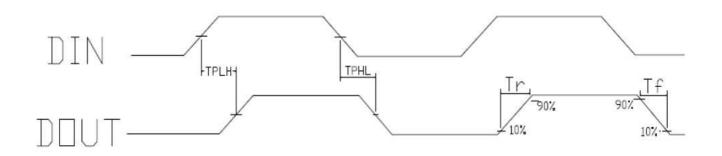
Recommended Operating Ranges (unless otherwise specified, Ta=-20 ~ +70 °C, VDD=4.5 ~ 5.5V, VSS=0V)

Parameter	Symbol	Min.	Тур.	Мах	Unit	Test conditions
Supply voltage	V _{DD}	3.5	5.2	5.5	V	-
R/G/B port pressure	V _{DS, MAX}	-	-	26	V	-
DOUT drive capability	IDон	-	49	-	mA	maximum source current
DOUT drive capability	IDol	-	-50	-	mA	maximum sink current
The signal input flip threshold	Vıн	0.7*+VDD	-		V	VDD=5.0V
The signal input flip threshold	VıL	-	-	0.3*+VDD	V	VDD=5.0V
The frequency of PWM	<i>F</i> _{РWM}	-	1.2	-	KHZ	-
Static power consumption	I _{DD}	-	1	-	mA	-



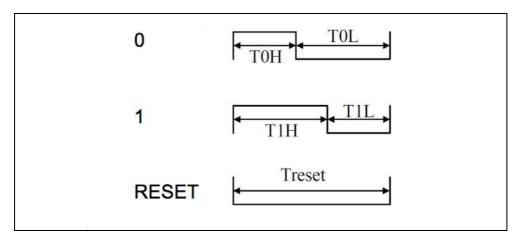
Switching Characteristics (unless otherwise specified, TA=25 °C)

Parameter	Symbol	Min.	Тур.	Max	Unit	Test conditions
The speed of data transmission	fDIN	-	800	-	KHZ	The duty ratio of 67% (data 1)
DOLIT transmission dolay	T _{PLH}	-	-	500	ns	DIN→DOUT
DOUT transmission delay	T _{PHL}	-	-	500	ns	DIN→DOUT
Lus Piec/Drop Time	Tr	-	100	-	ns	VDS=1.5
I _{OUT} Rise/Drop Time	Tf	-	100	-	ns	IOUT=9~18mA



Timing Waveforms

1. Input Code

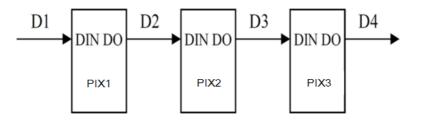




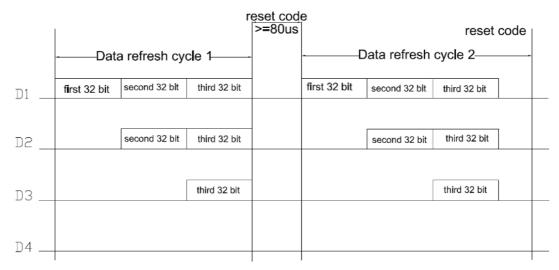
2. The data transmission time (TH+TL=1.25µs±600ns):

Name	Description	Typ. value	error
тон	0 code, high level time	0.3µs	±0.15µs
TOL	0 code, low level time	0.9µs	±0.15µs
T1H	1 code, high level time	0.9µs	±0.15µs
T1L	1 code, low level time	0.3µs	±0.15µs
Trst	Reset code, low level time	80µs	

3. Connection Scheme



4. Data Transfer Format



Note: the D1 sends data for MCU, D2, D3, D4 for data forwarding automatic shaping cascade circuit.

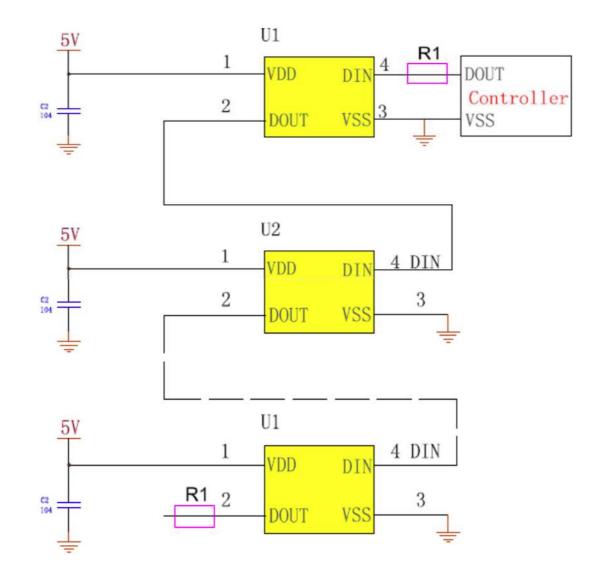
5. The data structure of 32bit

G7	G6	G5	G4	G3	G2	G1	G0	R7	R6	R5	R4
R3	R2	R1	RO	B7	B6	B5	B4	B3	B2	B1	BO
W7	W6	W5	W4	W3	W2	W1	wo				

Note: high starting, in order to send data (G7 - G6 -W0)



Typical Application Circuit



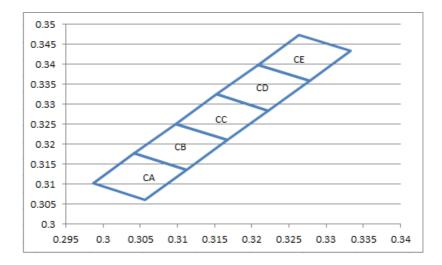
Product signal input and output must be connected in series with protection resistor R1. R1 depends on the size of the cascade amount, the greater the number of cascade, the smaller R1. The general recommended value is between $200-2K\Omega$, usually the recommended value is typical 500Ω .



Color Bin Specification

Name	Code	λd MIN (nm)	λd MAX (nm)
Ded	R1	620	625
Red	R2	625	630
Dhua	B5	460	465
Blue	B6	465	470
	G2	515	520
Green	G3	520	525
	G4	525	530

Cool White: 5000K~7500K



		CA		
Х	0.305649	0.29869	0.30422	0.31118
Y	0.30617	0.31022	0.31765	0.3136

		CB		
Х	0.311181	0.30422	0.30975	0.31671
Y	0.3136	0.31765	0.32508	0.32103

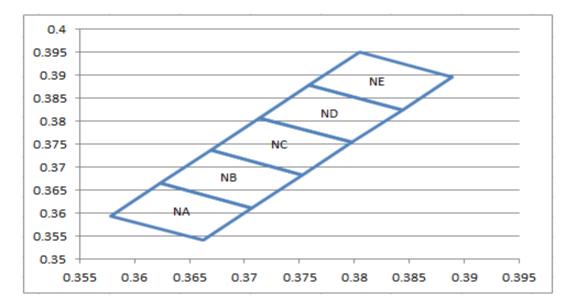
		CC		
Х	0.316713	0.30975	0.31529	0.32225
Y	0.32103	0.32508	0.33252	0.32847

		CD		
Х	0.322245	0.31529	0.32082	0.32778
Y	0.32847	0.33252	0.33995	0.3359

		CE		
Х	0.327777	0.32082	0.32635	0.33331
Y	0.3359	0.33995	0.34738	0.34333



Neutral White: 3500K~5000K



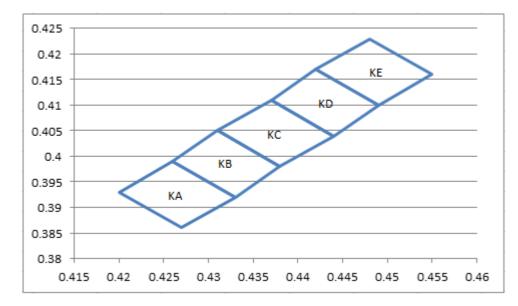
	NA						NB		
Х	0.3662	0.3578	0.3623	0.3707	X	0.3707	0.3623	0.3669	0.3753
Y	0.3541	0.3594	0.3666	0.3612	Y	0.3612	0.3666	0.3737	0.3683

		NC				ND					
Х	0.3753	0.3669	0.3714	0.3798		Х	0.3798	0.3714	0.3759	0.3844	
Y	0.3683	0.3737	0.3808	0.3754		Y	0.3754	0.3808	0.3879	0.3825	

		NE		
Х	0.3844	0.3759	0.3805	0.3889
Y	0.3825	0.3879	0.395	0.3897



Warm White: 2700K~3500K



KA									
Х	0.427	0.42	0.426	0.433					
Y	0.386	0.393	0.399	0.392					

KB								
Х	0.433	0.426	0.431	0.438				
Y	0.392	0.399	0.405	0.398				

		KC		
Х	0.438	0.431	0.437	0.444
Y	0.398	0.405	0.411	0.404

1			KD		
	Х	0.444	0.437	0.442	0.449
	Y	0.404	0.411	0.417	0.41

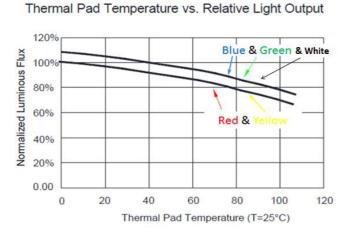
		KE		
Х	0.449	0.442	0.448	0.455
Y	0.41	0.417	0.423	0.416



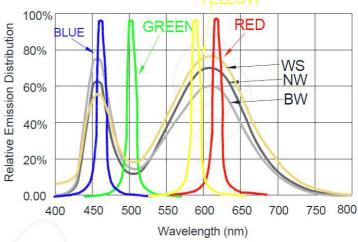
IN-PI55QATPRPGPBPW-XX 5050 RGBW LED 4-Pin with Integrated IC

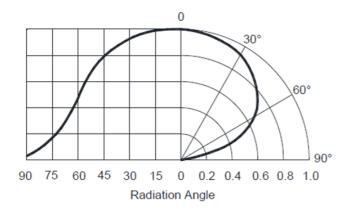
Wavelength Characteristics

LED Performance Graph



Typical Radiation Pattern 120°







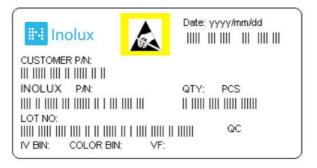
IN-PI55QATPRPGPBPW-XX 5050 RGBW LED 4-Pin with Integrated IC

Ordering Information

Product	Emission	lv (mcd)	Wavelength (Wd) / CCT	Orderable
	Color	Тур.	Тур.	Part Number
	R	300	625	
IN-PI55QATPRPGPBPW-60	G	850	520	IN-PI55QATPRPGPBPW-60
IN-FISSQATEREGEBEW-00	В	150	465	IN-FISSQATEREGEBEW-00
	W	1850	6000k	
	R	300	625	
IN-PI55QATPRPGPBPW-40	G	850	520	IN-PI55QATPRPGPBPW-40
IN-FISSQATEREGEBEW-40	В	150	465	IN-FISSQATEREGEBEW-40
	W	1850	4000k	
	R	300	625	
IN-PI55QATPRPGPBPW-30	G	850	520	IN-PI55QATPRPGPBPW-30
	B		465	IN-FIDDQATERPGPDPW-30
	W	1850	3000k	



Label Specifications



Inolux P/N:

Ι		Ν	PI	-	55	Q	А	Т	(X)		-	XX	-	Х	Х	Х	Х
			Product		Package	Die Qty.	Variation	Orientation	Current	Color		Color Temperature of White				mized p-off	
In	nolu	ux	PI- Single trace IC PC- Clock Function IC		55QA =	5.0 x 5.0	x 1.6 mm	T = Top Mount	P=12mA 5 = 5mA	R = 624nm G = 520nm B = 470nm W = 2700K-7000K		60: Cool White 40: Neutral White 30: Warm White					

Lot No.:

Z	2	0	1	7	01	24	001
Internal		Year (2017	2019 \	Month	Date	Serial	
Tracker		fear (2017)	, 2018,)	wonth	Date	Serial	



Precautions

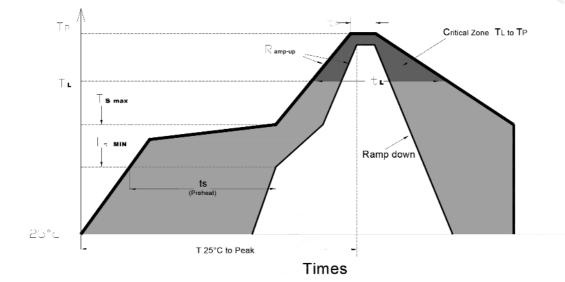
Please read the following notes before using the product:

- 1. Storage
- 1.1 Do not open moisture proof bag before the products are ready to use.
- 1.2 Before opening the package, the LEDs should be kept at 30 $^\circ\!\!{\rm C}$ or less and 80%RH or less.
- 1.3 The LEDs should be used within a year.
- 1.4 After opening the package, the remaining LEDs should be kept in a resealed bag.
- 1.5 The LEDs require mandatory baking before usage. Baking treatment listed below.
- 1.6 If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

*Baking treatment: $60\pm5^{\circ}$ C for24 hours.



2. Soldering Condition Recommended soldering conditions:



Profile Feature	Lead-Free Solder		
Average Ramp-Up Rate (Ts _{max} to Tp)	3℃/second max.		
Preheat: Temperature Min (Ts _{min})	150℃		
Preheat: Temperature Min (Ts _{max})	200°C		
Preheat: Time(ts _{min to} ts _{max})	60-180 seconds		
Time Maintained Above: Temperature (T _L)	217 °C		
Time Maintained Above: Time (t _L)	60-150 seconds		
Peak/Classification Temperature (T P)	240 °C		
Time Within 5 $^\circ\!$	<10 seconds		
Ramp-Down Rate	6°C/second max.		
Time 25 $^\circ\!$	<6 minutes max.		

Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED.



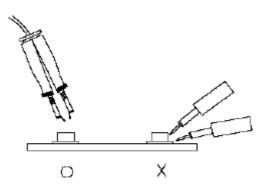
IN-PI55QATPRPGPBPW-XX 5050 RGBW LED 4-Pin with Integrated IC

3. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260° C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

4. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



5. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wristband or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.



Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	05-31-2018
Format adjustment		1.1	07-01-2018
Format adjustment		1.2	08-06-2018
Revise precautions	14	1.1	07-31-2019

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